



# TEA19162T/3

PFC controller

Rev. 3 — 7 May 2018

Product data sheet

## 1 General description

The TEA19162T and TEA19161T are combined controller (combo) ICs for resonant topologies including PFC. They provide high efficiency at all power levels. Together with the TEA1995T dual LLC resonant SR controller, a cost-effective resonant power supply can be built. This power supply meets the efficiency regulations of Energy Star, the Department of Energy (DoE), the Eco-design Directive of the European Union, the European Code of Conduct, and other guidelines.

The TEA19162T is a Power Factor Correction (PFC) controller. The IC communicates with the TEA19161T on start-up sequence and protections. It also enables a fast latch reset mechanism. To maximize the overall system efficiency, the TEA19161T allows setting the TEA19161T PFC to burst mode at a low output power level.

Using the TEA19161T and TEA19162T combo together with the TEA1995T secondary synchronous rectifier controller, a highly efficient and reliable power supply can be designed with a minimum of external components. The target output power is between 90 W and 500 W.

The system provides a very low no-load input power ( $< 75$  mW; total system including the TEA19161T/TEA19162T combo and the TEA1995T) and high efficiency from minimum to maximum load. So, no additional low-power supply is required.



## 2 Features and benefits

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### 2.1 Distinctive features

- Complete functionality as TEA19161T/TEA19162T combo
- Integrated X-capacitor discharge without additional external components
- Universal mains supply operation (70 V (AC) to 276 V (AC))
- Integrated soft start and soft stop
- Accurate boost voltage regulation

### 2.2 Green features

- Valley/zero voltage switching for minimum switching losses
- Frequency limitation to reduce switching losses
- Reduced supply current (200  $\mu$ A) when in burst mode

### 2.3 Protection features

- Safe restart mode for system fault conditions
- Continuous mode protection with demagnetization detection
- Accurate OverVoltage Protection (OVP)
- Open-Loop Protection (OLP)
- Short-Circuit Protection (SCP)
- Internal and external IC OverTemperature Protection (OTP)
- Low and adjustable OverCurrent Protection (OCP) trip level
- Adjustable brownin/brownout protection
- Supply UnderVoltage Protection (UVP)

## 3 Applications

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- Desktop and all-in-one PCs
- LCD television
- Notebook adapter
- Printers
- Gaming console power supplies

## 4 Ordering information

Table 1. Ordering information

| Type number | Package |                                                           |         |
|-------------|---------|-----------------------------------------------------------|---------|
|             | Name    | Description                                               | Version |
| TEA19162T/3 | SO8     | plastic small outline package; 8 leads; body width 3.9 mm | SOT96-1 |

## 5 Marking

Table 2. Marking codes

| Type number | Marking code |
|-------------|--------------|
| TEA19162T/3 | EA19162      |

## 6 Block diagram

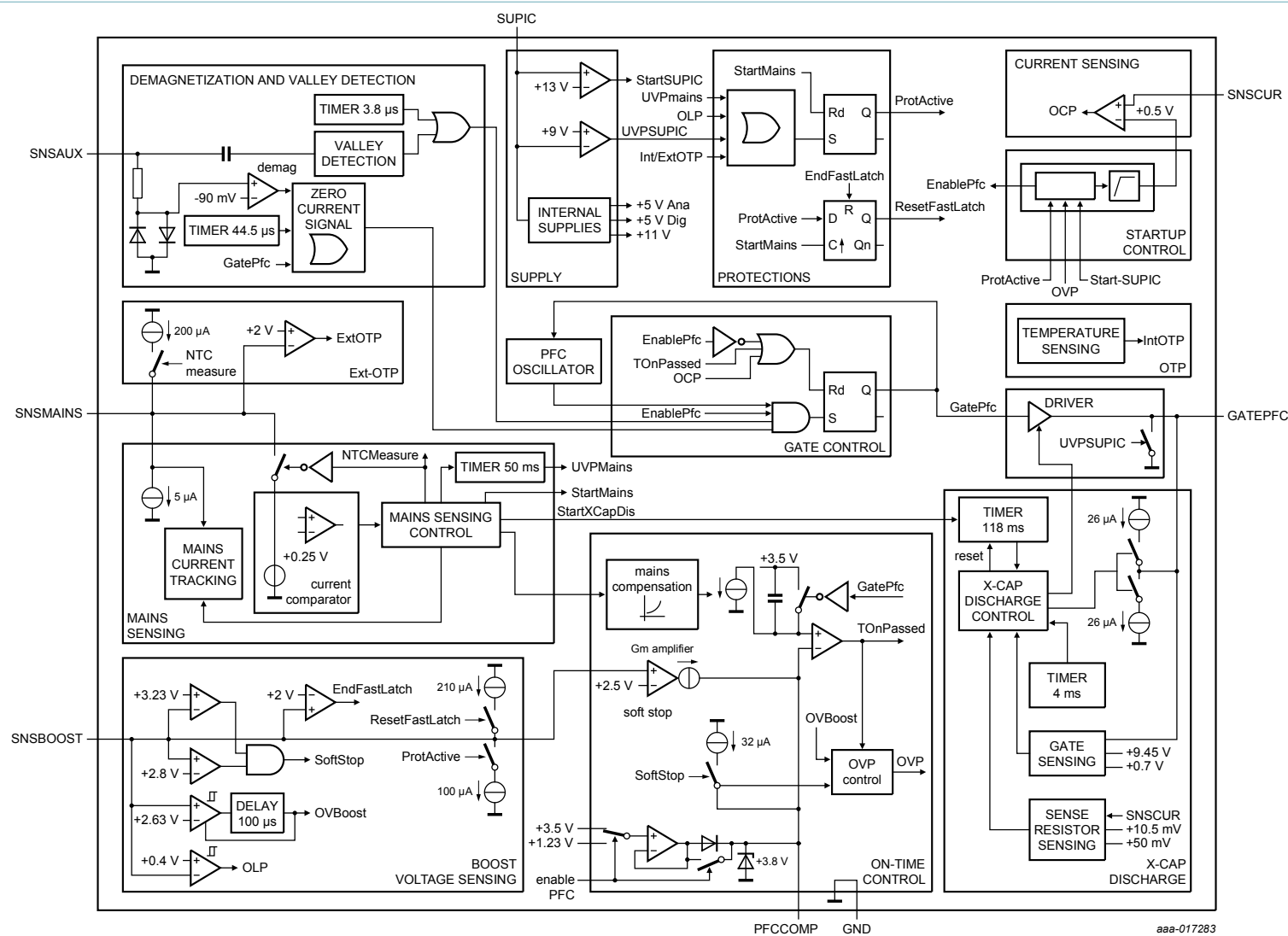
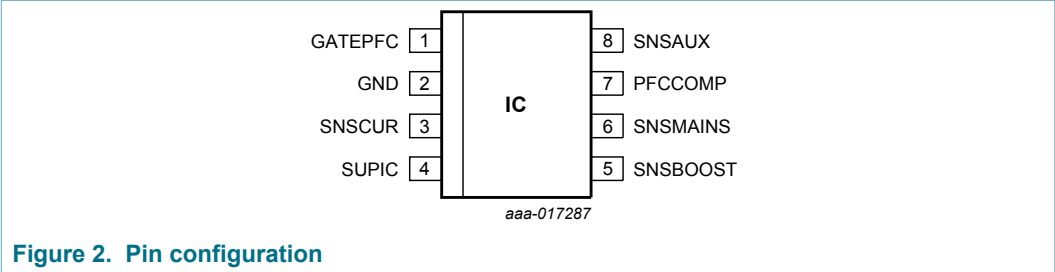


Figure 1. Block diagram

7 Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

| Symbol   | Pin | Description                                                                          |
|----------|-----|--------------------------------------------------------------------------------------|
| GATEPFC  | 1   | gate driver output for PFC                                                           |
| GND      | 2   | ground                                                                               |
| SNSCUR   | 3   | programmable current sense input for PFC                                             |
| SUPIC    | 4   | supply voltage                                                                       |
| SNSBOOST | 5   | sense input for PFC output voltage                                                   |
| SNSMAINS | 6   | sense input for mains voltage                                                        |
| PFCCOMP  | 7   | frequency compensation pin for PFC                                                   |
| SNSAUX   | 8   | input from auxiliary winding for demagnetization timing and valley detection for PFC |

## 8 Functional description

### 8.1 General control

The TEA19162T is a controller for a power factor correction circuit. [Figure 3](#) shows a typical configuration.

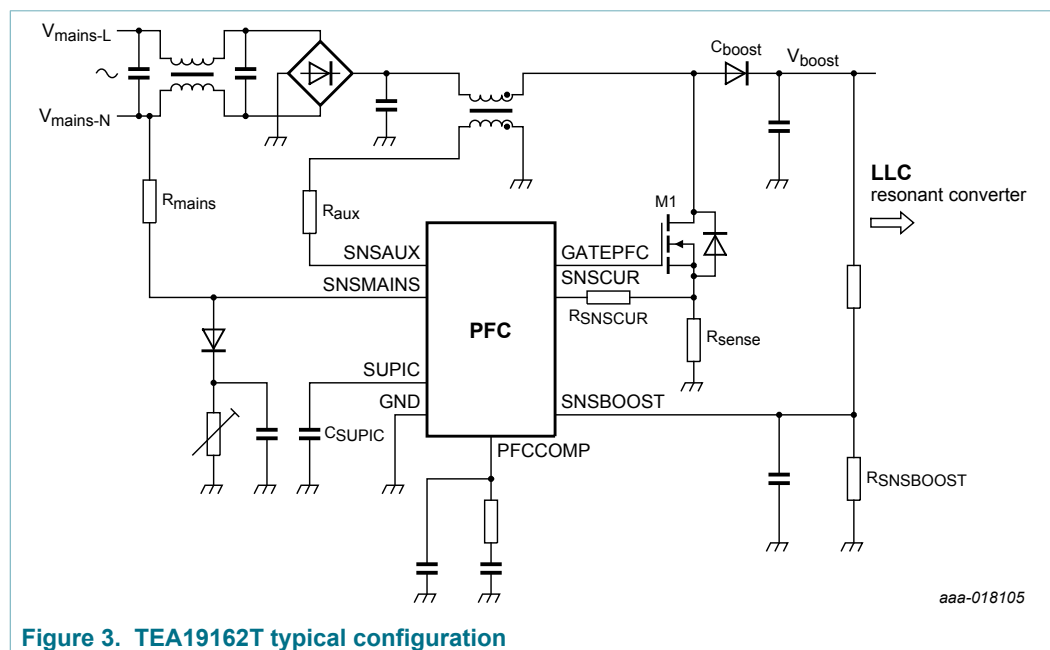


Figure 3. TEA19162T typical configuration

### 8.2 Supply voltage and start-up

When using the TEA19162T (PFC) together with the TEA19161T (LLC), connect the SUPIC pin of the TEA19162T to the SUPIC pin of the TEA19161T. The LLC controller then supplies the PFC either via the high-voltage supply pin of the TEA19161T (SUPHV) or via the primary auxiliary winding.

To enable the PFC, the SUPIC voltage must exceed the  $V_{\text{start(SUPIC)}}$  level (13 V typical). Although the  $V_{\text{start(SUPIC)}}$  level of the LLC is higher than the  $V_{\text{start(SUPIC)}}$  level of the PFC, the system ensures that both converters (PFC and LLC) start up at the same time. Therefore, the LLC initially pulls down the SNSBOOST pin, disabling the PFC until the SUPIC voltage reaches the  $V_{\text{start(SUPIC)}}$  level of the LLC.

When both conditions are met and the SNSMAINS is above the brownin level, the PFC starts up via an internal soft start (see [Figure 4](#)).

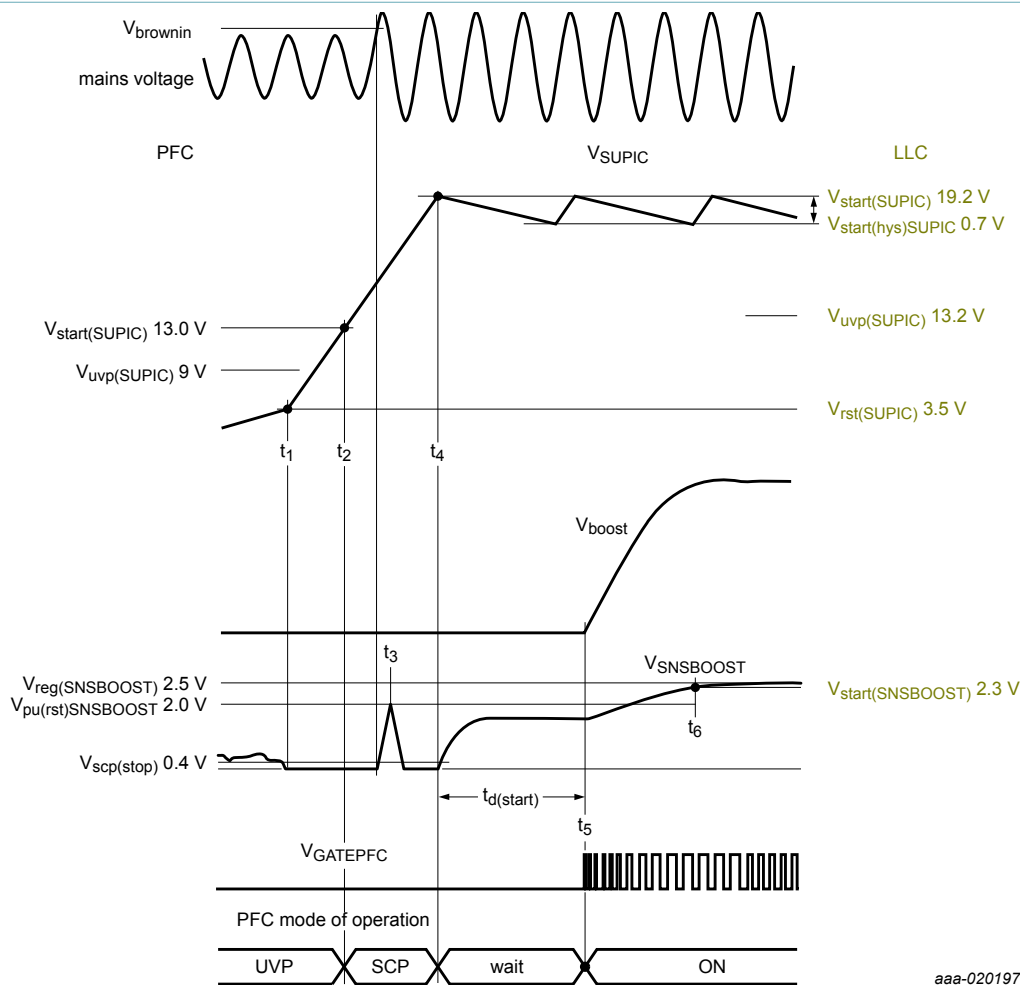


Figure 4. Start-up of the PFC and LLC

The exact start-up sequence of the PFC depends on the availability of start-up conditions (brownin level,  $V_{start(SUPIC)}$  of the PFC, and  $I_{en(PFC)}$ ).

Before  $t_1$ , the SUPIC voltage is below the UVP level of the PFC and LLC. When the LLC reaches a minimum supply voltage level ( $t_1$ ), the LLC pulls down the SNSBOOST pin to disable the PFC.

At  $t_2$ , the SUPIC voltage reaches the start level of the PFC converter. However, as the LLC pulls low the SNSBOOST to below the PFC short protection level, the PFC is still off. When the mains voltage exceeds the brownin level, the PFC resets its latched protection by pulling  $V_{SNSBOOST}$  to the  $V_{pu(rst)SNSBOOST}$  level ( $t_3$ ). However, the LLC returns it to the protection mode. When at  $t_4$  the SUPIC voltage reaches the start level of the LLC, the SNSBOOST is released. The SNSBOOST voltage increases because of the resistive divider which is connected to the PFC bus voltage. To ensure that this voltage is representative of the  $V_{boost}$  voltage before the system actually starts to switch, an additional delay ( $t_{d(start)}$ ; 3.62 ms) is active before the PFC starts switching ( $t_5$ ).

Another important condition for the PFC start is a precharge of the compensation circuitry connected to the PFCCOMP pin. This condition is met when the current out of the PFCCOMP pin  $< |I_{en(PFCCOMP)}|$ .

When at t6 the SNSBOOST voltage reaches the start level of the LLC ( $V_{\text{start(SNSBOOST)}}$ ), the LLC converter starts to switch.

When  $V_{\text{SUPIC}} < V_{\text{uvp(SUPIC)}}$ , the PFC controller stops switching immediately.

### 8.3 Protections

[Table 4](#) gives an overview of the available protections.

**Table 4. Protections overview**

| Protection            | Description                                                  | Action                                                                                                         | LLC <sup>[1]</sup> |                               |
|-----------------------|--------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------|--------------------|-------------------------------|
| UVP-SUPIC             | undervoltage protection SUPIC                                | PFC = off; restart when $V_{\text{SUPIC}} > V_{\text{start(SUPIC)}}$ ; SNSBOOST pulled low, disabling the LLC. | off                | <a href="#">Section 8.2</a>   |
| OTP-internal          | internal overtemperature protection                          | latched; SNSBOOST pulled low, disabling the LLC.                                                               | off                | <a href="#">Section 8.3.1</a> |
| OTP-external          | external overtemperature protection                          | latched; SNSBOOST pulled low, disabling the LLC.                                                               | off                | <a href="#">Section 8.3.2</a> |
| brownout-mains        | undervoltage protection mains                                | PFC = off; restart when $I_{\text{SNSMAINS}} > I_{\text{bi}}^{[2]}$                                            | -                  | <a href="#">Section 8.3.2</a> |
| SoftStop-OVP-SNSBOOST | overvoltage protection boost voltage followed by a soft stop | PFC = off via soft stop; restart when $V_{\text{SNSBOOST}} < V_{\text{ovp(start)}}$                            | -                  | <a href="#">Section 8.3.3</a> |
| OVP-SNSBOOST          | overvoltage protection boost voltage                         | PFC = off; restart when $V_{\text{SNSBOOST}} < V_{\text{ovp(SNSBOOST)}}$                                       | -                  | <a href="#">Section 8.3.4</a> |
| SCP-SNSBOOST          | short-circuit protection                                     | PFC = off; restart when $V_{\text{SNSBOOST}} > V_{\text{scp(start)}}$                                          | -                  | <a href="#">Section 8.3.5</a> |
| OLP-PFC               | open-loop protection                                         | PFC = off; restart when $V_{\text{SNSBOOST}} > V_{\text{scp(start)}}$                                          | -                  | <a href="#">Section 8.3.5</a> |
| OCP                   | overcurrent protection                                       | PFC MOSFET switched off, continue operation                                                                    | -                  | <a href="#">Section 8.3.6</a> |

[1] Some protections also disable the LLC (see [Section 8.5.1](#)).

[2] At start-up, the PFC disables the LLC converter until the mains voltage exceeds the brownin level.

#### 8.3.1 Internal OverTemperature Protection (OTP)

An accurate internal temperature protection is provided in the circuit. When the junction temperature exceeds the thermal shutdown temperature ( $T_{\text{pl(IC)}}$ ), the IC stops switching.

The internal overtemperature protection is a latched protection. It also disables the LLC converter by pulling down the SNSBOOST pin.

### 8.3.2 Brownin/brownout and external overtemperature protection

On the TEA19162T, the mains measurement and external temperature are combined at the SNSMAINS pin (see [Figure 5](#)).

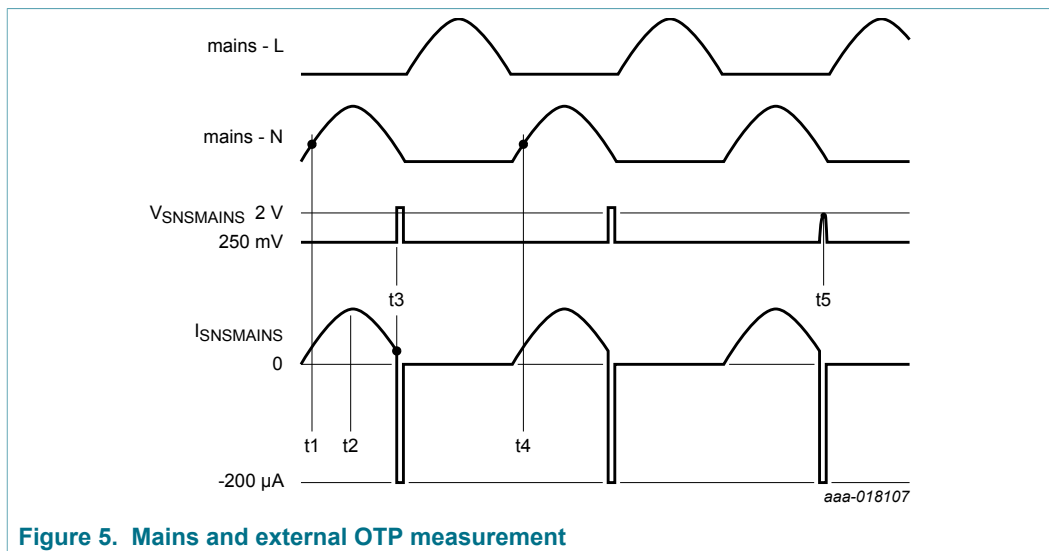


Figure 5. Mains and external OTP measurement

At  $t_1$ , the voltage at the SNSMAINS pin is internally regulated to  $V_{\text{regd(SNSMAINS)}}$  (250 mV). The current into the SNSMAINS pin is a measure of the system input mains voltage. The TEA19162T continuously measures the SNSMAINS current and waits until it detects a peak in the measured current ( $t_2$ ). This peak current value is internally stored and used as an input for the brownout/brownin detection and the mains compensation.

When, at  $t_3$ , the current into the SNSMAINS pin is well below the brownin level ( $< I_{\text{en(NTC)}}$ ), the controller starts to measure the value of the external NTC. The external NTC is measured by sourcing a current ( $I_{\text{o(SNSMAINS)}}$ ) out of the SNSMAINS pin. When, after a maximum measuring time of  $t_{\text{det(NTC)max}}$  (1 ms), the voltage remains below  $V_{\text{det(SNSMAINS)}}$  during four consecutive NTC measurements, the OTP protection is triggered ( $t_5$ ).

To prevent the PFC from operating at very low mains input voltages, the PFC stops switching when the measured peak current drops to below  $I_{\text{bo}}$ . When the measured current exceeds  $I_{\text{bi}}$ , the PFC restarts with a soft start.

### 8.3.3 Soft stop overvoltage protection (SNSBOOST pin)

When the SNSBOOST voltage is between the  $V_{\text{det(L)SNSBOOST}}$  and  $V_{\text{det(H)SNSBOOST}}$ , the TEA19162T stops switching via a soft stop. The TEA19161T uses this function to force the TEA19162T to operate in burst mode with a specific duty cycle (see [Section 8.5.2](#)). Audible noise is avoided because at the end of a switching period, the PFC stops via a soft stop. After an OVP event, the system always starts via a soft start.

### 8.3.4 Overvoltage protection (SNSBOOST pin)

To prevent output overvoltage during load steps and mains transients, an overvoltage protection circuit is built in.

When the voltage on the SNSBOOST pin exceeds the  $V_{ovp(stop)}$  level and is outside the  $V_{det(L)SNSBOOST}$  and  $V_{det(H)SNSBOOST}$  window for a minimum period of  $t_{d(ovp)}$  (100  $\mu$ s), switching of the power factor correction circuit is inhibited. When the SNSBOOST pin voltage drops to below the  $V_{ovp(start)}$  ( $V_{ovp(stop)} - V_{hys(ovp)}$ ) level again, the switching of the PFC recommences. The IC always restarts with a soft start (see [Section 8.4.1](#)).

### 8.3.5 PFC open-loop protection (SNSBOOST pin)

The PFC does not start switching until the voltage on the SNSBOOST pin exceeds  $V_{scp(start)}$ . This function acts as short circuit protection for the boost voltage (SCP-SNSBOOST; see [Table 4](#)).

### 8.3.6 Overcurrent protection (SNSCUR pin)

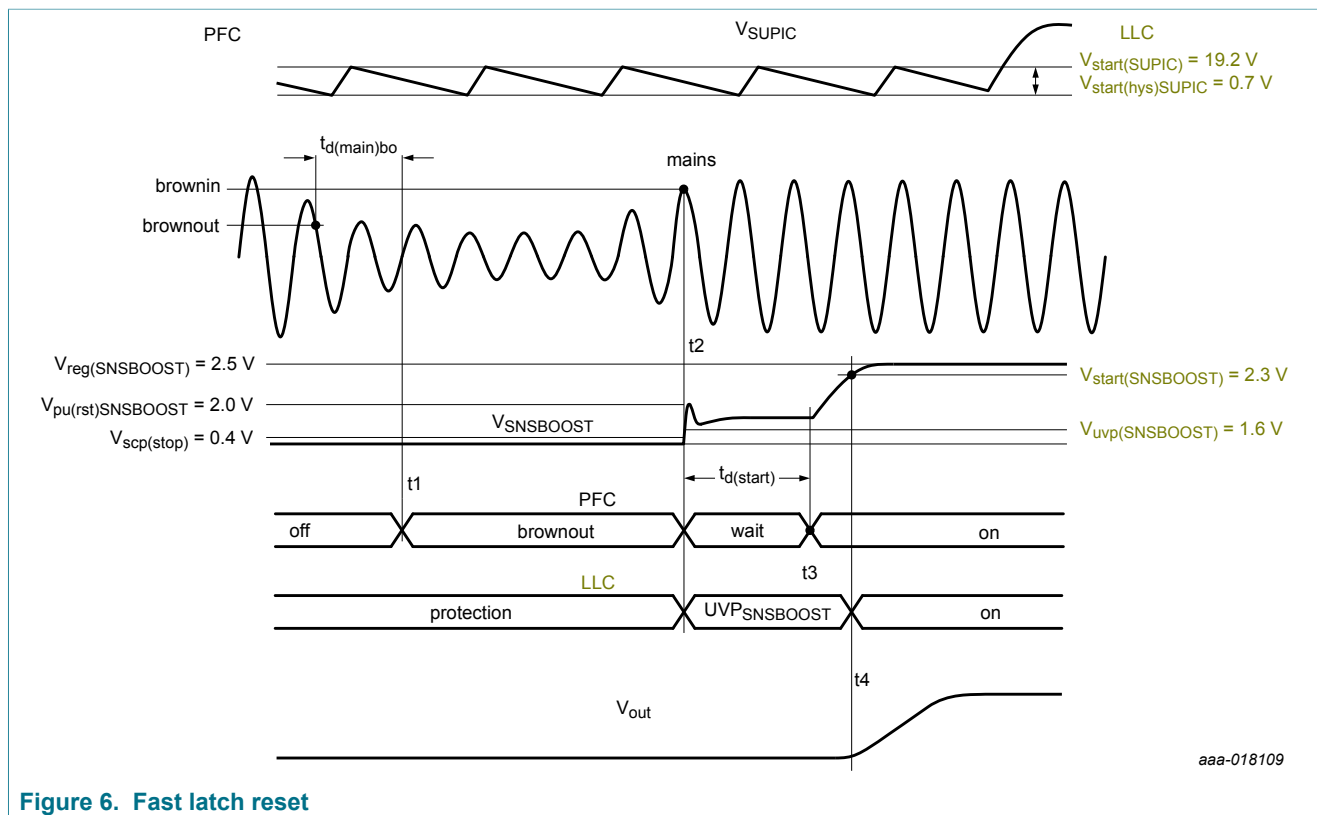
Sensing the voltage across an external sense resistor,  $R_{sense}$ , on the source of the external MOSFET, limits the maximum peak current cycle-by-cycle. The voltage is measured via the SNSCUR pin.

### 8.3.7 Fast latch reset

The restart of the system after a protection is triggered depends on the type of protection. In a safe restart protection (only applicable for the LLC), the system typically restarts after the restart delay time (1 s).

It is different for latched protections. Typically, in a latched protection, the SUPIC must reach the undervoltage protection level to release the protection mode and to restart the system. The release/restart can only be achieved by disconnecting the mains.

In the protection mode, the TEA19161T regulates the voltage of the SUPIC pin to its start level. The PFC output capacitor supplies the SUPIC pin via the SUPHV pin of the TEA19161T. So it takes a long time before the voltage of the SUPIC pin drops below its undervoltage level after the mains is disconnected. To prevent this delay, a special fast latch reset function is implemented in the TEA19162T, which also releases the protection mode when the mains is reconnected.



Before  $t_1$ , the LLC (and/or PFC) is in a (latched) protection and pulls down the SNSBOOST pin, which also disables the PFC.

When the mains voltage drops to below the brownout level ( $I_{bo}$ ) and the time  $t_{d(det)bo}$  (50 ms) expires ( $t_1$ ), the PFC enters the brownout protection mode. When, in the brownout protection mode, the mains voltage increases again and exceeds the brownin level ( $I_{bi}$ ;  $t_2$ ), the PFC pulls up the SNSBOOST voltage to the  $V_{pu(rst)SNSBOOST}$  level (see Figure 6). Because the  $V_{pu(rst)SNSBOOST}$  level of the PFC exceeds the  $V_{uvp(SNSBOOST)}$  level of the LLC, the LLC converter resets the protection mode. However, switching is still inhibited as the SNSBOOST voltage remains below the start level ( $V_{start(SNSBOOST)}$ ) of the LLC. The SUPIC voltage is still regulated to the  $V_{start(SUPIC)}$  level of the LLC converter. To ensure that the voltage at the SNSBOOST pin accurately reflects the output voltage of the PFC, the PFC converter starts after a delay time ( $t_{d(start)}$ ) ( $t_3$ ). The start of the PFC converter is followed by a start-up of the LLC converter ( $t_4$ ).

## 8.4 Power factor correction regulation

The power factor correction circuit operates in quasi-resonant or discontinuous conduction mode with valley switching. The next primary stroke is only started when the previous secondary stroke has ended and the voltage across the PFC MOSFET has reached a minimum value. To detect transformer demagnetization and the minimum voltage across the external PFC MOSFET switch, the voltage on the SNSAUX pin is used.

### 8.4.1 Soft start (SNSCUR pin)

To prevent audible transformer noise at start-up or during hiccup, the soft start function slowly increases the transformer peak current (see [Figure 7](#)).

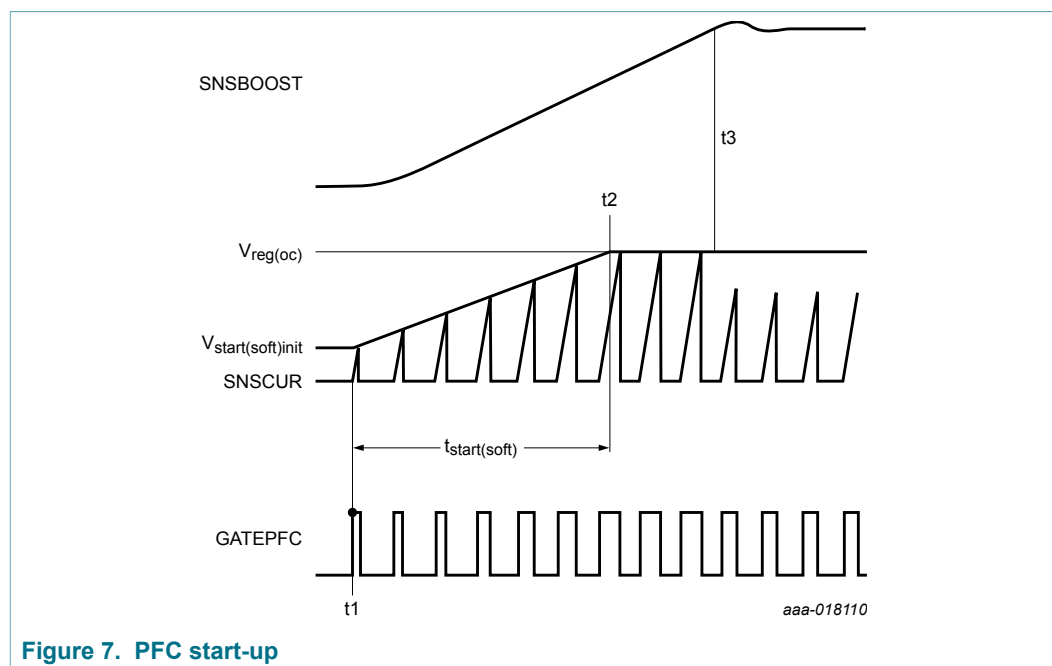


Figure 7. PFC start-up

At  $t_1$ , all conditions to start up the PFC are fulfilled. The maximum voltage on the SNSCUR pin is limited to  $V_{\text{start(soft)init}}$  (125 mV). When the PFC starts switching, the maximum SNSCUR voltage is increased to  $V_{\text{reg(oc)}}$  within a time period of  $t_{\text{start(soft)}}$  (3.62 ms) or until the  $t_{\text{on}}$  regulation limits the on-time of the PFC external MOSFET.

### 8.4.2 $t_{\text{on}}$ control

The power factor correction circuit is operated in  $t_{\text{on}}$  control. The resulting mains harmonic reduction of a typical application is well within the class-D requirements.

The following circuits determine the on-time of the external PFC MOSFET:

- The error amplifier and the loop compensation which define the voltage on the PFCCOMP pin. At  $V_{\text{tonzero(PFCCOMP)}}$  (3.5 V), the on-time is reduced to zero. At  $V_{\text{tonmax(PFCCOMP)}}$  (1.23 V), the on-time is at a maximum.
- Mains compensation which uses the current through the SNSMAINS pin to represent the mains input voltage level.

### 8.4.3 PFC error amplifier (PFCCOMP and SNSBOOST pins)

The boost voltage is divided using a high-ohmic resistive divider and is supplied to the SNSBOOST pin. The transconductance error amplifier, which compares the SNSBOOST voltage with an accurate trimmed reference voltage ( $V_{\text{reg(SNSBOOST)}}$ ) is connected to this pin. The external loop compensation network on the PFCCOMP pin filters the output current. In a typical application, a resistor and two capacitors set the regulation loop bandwidth.

The transconductance of the error amplifier is not constant. To avoid triggering the OVP during start-up and during a converter transient response, the transconductance is increased to a level of  $g_{m(\text{high})}$  starting at  $V_{gm(\text{high})\text{start}}$  (see Figure 8).

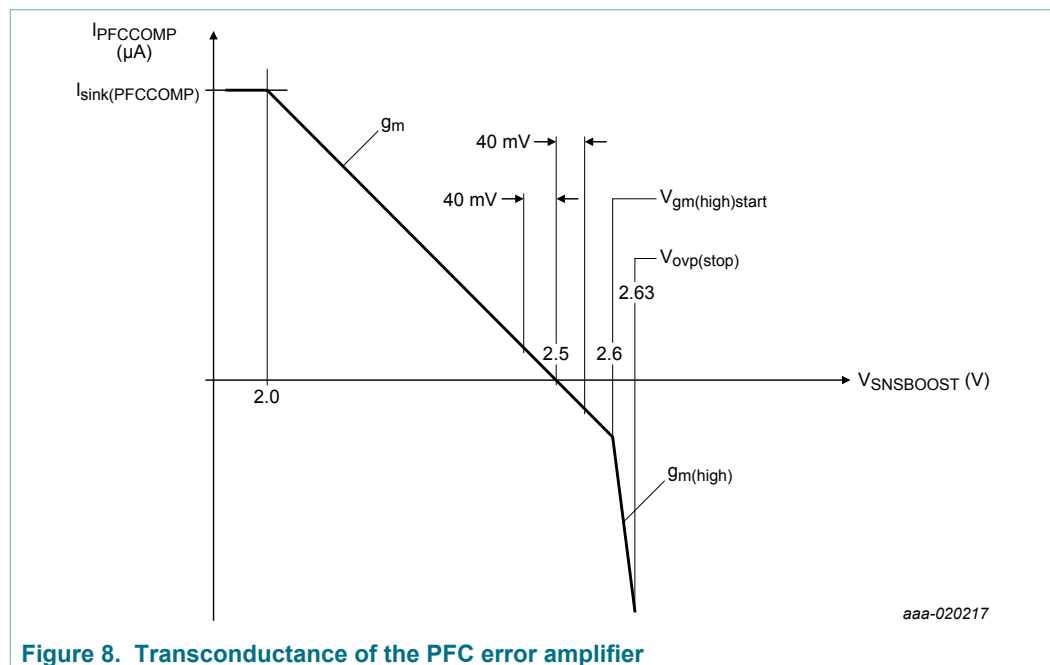


Figure 8. Transconductance of the PFC error amplifier

#### 8.4.4 Valley switching and demagnetization (SNSAUX pin)

To ensure that the TEA19162T operates in discontinuous or quasi-resonant mode, the PFC MOSFET is switched on after the transformer is demagnetized. To reduce switching losses and ElectroMagnetic Interference (EMI), the next stroke is started when the PFC MOSFET drain-source voltage is at its minimum (valley switching). The demagnetization and valley detection are measured via the SNSAUX pin.

If no demagnetization signal is detected on the SNSAUX pin, the controller generates a demagnetization signal ( $t_{to(\text{demag})}$ ; 44.5  $\mu\text{s}$  typical) after the external MOSFET is switched off.

If no valley signal is detected on the PFCAUX pin, the controller generates a valley signal ( $t_{to(\text{vrec})}$ ; 3.8  $\mu\text{s}$  typical) after demagnetization is detected.

To protect the internal circuitry, for example during lightning events, connect a 5 k $\Omega$  series resistor ( $R_{aux}$ ; see Figure 13) to the SNSAUX pin. Also connect a 1 k $\Omega$  (typical) external sense resistor ( $R_{SNSCUR}$ ; see Figure 13) to the SNSCUR pin. To prevent incorrect switching due to external disturbance, place the resistors close to the IC.

#### 8.4.5 Frequency limitation

To optimize the transformer and minimize switching losses, the switching frequency is limited to  $f_{sw(\text{PFC})\text{max}}$ . If the frequency for quasi-resonant operation exceeds the  $f_{sw(\text{PFC})\text{max}}$  limit, the system enters Discontinuous Conduction Mode (DCM). When the system is in DCM, the PFC MOSFET switches on at a minimum voltage across the switch (valley switching).

To ensure correct control of the PFC MOSFET under all circumstances, the minimum off-time is limited at  $t_{off(\text{PFC})\text{min}}$ .

#### 8.4.6 Mains voltage compensation (SNSMAINS pin)

The equation for the transfer function of a power factor corrector contains the square of the mains input voltage. In a typical application, the result is a low bandwidth for low mains input voltages. At high mains input voltages, the Mains Harmonic Reduction (MHR) requirements may be hard to meet.

To compensate for the mains input voltage influence, the TEA19162T contains a correction circuit. The input voltage is measured via the SNSMAINS pin (see [Section 8.3.2](#)) and the information is fed to an internal mains compensation circuit (see [Figure 1](#)). With this compensation, it is possible to keep the regulation loop bandwidth constant over the full mains input range. The result is that a mains voltage independent transient response on load steps is yielded, while still complying with class-D MHR requirements.

In a typical application, an external circuitry at the PFCCOMP pin (see [Section 8.4.3](#)) sets the bandwidth of the regulation loop.

#### 8.4.7 Active X-capacitor discharge

The TEA19162T provides an active X-capacitor discharge after the mains voltage is disconnected. When the mains input voltage (and so also the measured current into the SNSMAINS pin) increases (see [Figure 9](#),  $t_2 - t_1$ ), the system assumes the presence of a mains voltage. When the mains voltage does not increase for a minimum period of  $t_{d(dch)}$ , the active X-capacitor discharge is activated ( $t_3$ ).

When the active X-capacitor discharge function is activated, the X-capacitor is discharged via the external PFC MOSFET (see [Figure 10](#)). To avoid any increase of the PFC output voltage, the external PFC MOSFET is slowly turned on until a small current is detected via the SNSCUR pin (see [Figure 9](#),  $t_4$ ). A slow increase of the GATEPFC voltage is achieved via a current source ( $I_{ch(GATEPFC)}$ ) that slowly charges the external gate-source capacitance of the external MOSFET.

When the voltage at the SNSCUR exceeds  $V_{ch(stop)SNSCUR}$  level (10.5 mV), the voltage at the GATEPFC pin slowly decreases by activating a current sink ( $I_{dch(GATEPFC)}$ ). As a result, the gate-source capacitance of the external MOSFET is discharged. When the voltage on the GATEPFC pin drops to below  $V_{dch(stop)GATEPFC}$  level (0.7 V), the current sink is switched off. The charge/discharge cycle is repeated after the period  $t_{off(dch)}$  ( $t_5$ ). As for a typical power MOSFET the duration of charge/discharge pulses on the GATEPFC pin is shorter than 2 ms,  $T_p$  (4 ms typical) defines the pulse repetition time.

When the voltage on the GATEPFC pin exceeds  $V_{dch(GATEPFC)}$  while the voltage on the SNSCUR pin is still below  $V_{ch(stop)SNSCUR}$ , the system assumes a full discharge of the X-capacitor. It starts to ramp down the GATEPFC voltage. Unless the mains is reconnected, the next active X-capacitor discharge cycle is started after  $t_{d(dch)}$ . Reconnecting the mains is detected via a positive  $di/dt$  at the SNSMAINS pin.

While the GATEPFC pin discharges the X-capacitor, the mains can be reconnected. In that case, the current through the external MOSFET increases rapidly. If the voltage on the SNSCUR pin exceeds  $V_{dch(SNSCUR)}$ , the internal driver stage rapidly turns off the GATEPFC pin. When the mains is disconnected again (measured via the SNSMAINS pin), the next active X-capacitor discharge cycle starts, followed by a delay of  $t_{d(dch)}$ .

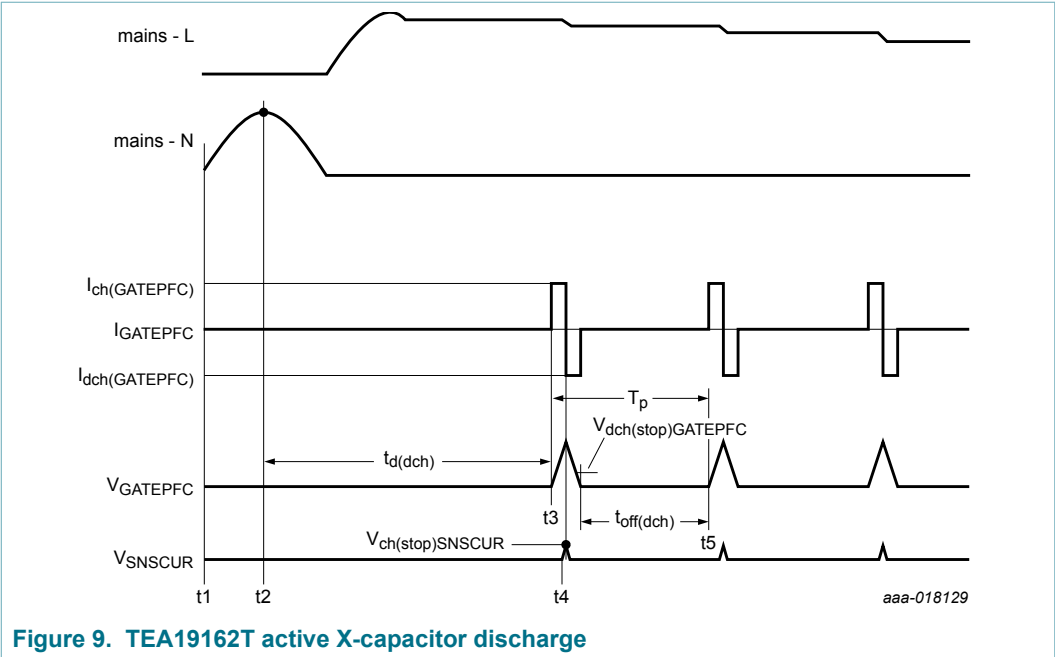
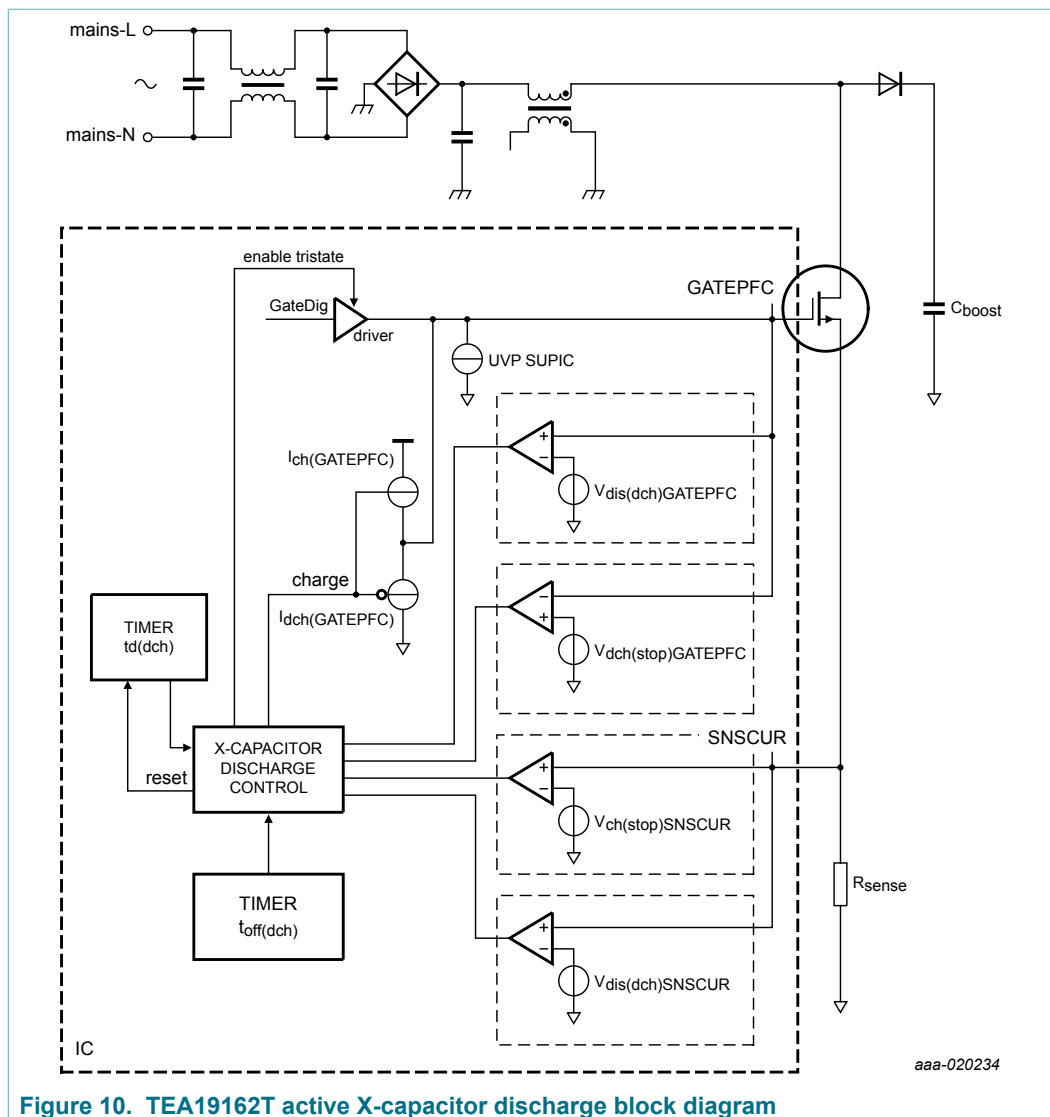


Figure 9. TEA19162T active X-capacitor discharge



## 8.5 PFC-LLC communication protocol

The TEA19162T (PFC controller) is designed to cooperate with the TEA19161T (LLC controller) in one system. Both controllers can be seen as a combo IC, split up into two packages. All required functionality between the TEA19162T and TEA19161T is arranged via the combined SUPIC and SNSBOOST pins.

Both controllers are supplied via the SUPIC pin (see [Section 8.2](#)). The SNSBOOST pin is used to communicate about the protection states of both controllers. The TEA19161T forces the TEA19162T to enter burst mode also using the SNSBOOST pin.

### 8.5.1 Protections

When a protection is triggered in the PFC or the LLC, it can also disable the other converter. For example, if an OVP is detected at the LLC, both converters are stopped. Also, at initial start-up, the PFC disables the LLC converter until the brownin level of the mains voltage is detected.

The SNSBOOST pin is used for the communication about such protection states. By pulling down the SNSBOOST pin below the  $V_{\text{uvp(SNSBOOST)}}$  level of the LLC converter, the PFC can disable the LLC converter. Similarly, by pulling down the SNSBOOST pin below the short protection level  $V_{\text{scp(stop)}}$  of the PFC converter, the LLC can disable the PFC.

[Table 4](#) in [Section 8.3](#) gives an overview of all protections in the PFC converter. The PFC protections that also disable the LLC are listed in the LLC-column.

When the mains voltage initially drops to below the brownout level and then increases to above the brownin level, all protections of the PFC and the LLC are reset. A reset of all protections is also communicated via the SNSBOOST pin by pulling it up to the  $V_{\text{pu(rst)SNSBOOST}}$  level (see [Section 8.3.7](#)).

The IC starts and remains in the protection mode until the mains brownin level is reached. The IC current consumption is then at power-saving level.

### 8.5.2 PFC burst mode

Based on the output power level of the LLC converter, the LLC determines when the PFC enters burst mode. During the burst mode, the LLC converter disables the PFC by increasing the SNSBOOST voltage to between  $V_{\text{det(L)SNSBOOST}}$  and  $V_{\text{det(H)SNSBOOST}}$  (see [Figure 11](#)). It ensures a soft start and a soft stop at the start and the end of a switching period, respectively. This increase in the voltage on the SNSBOOST pin is achieved by an additional current out of the LLC converter towards the SNSBOOST pin. The additional current creates a positive voltage shift because of the external resistive network at the SNSBOOST pin.

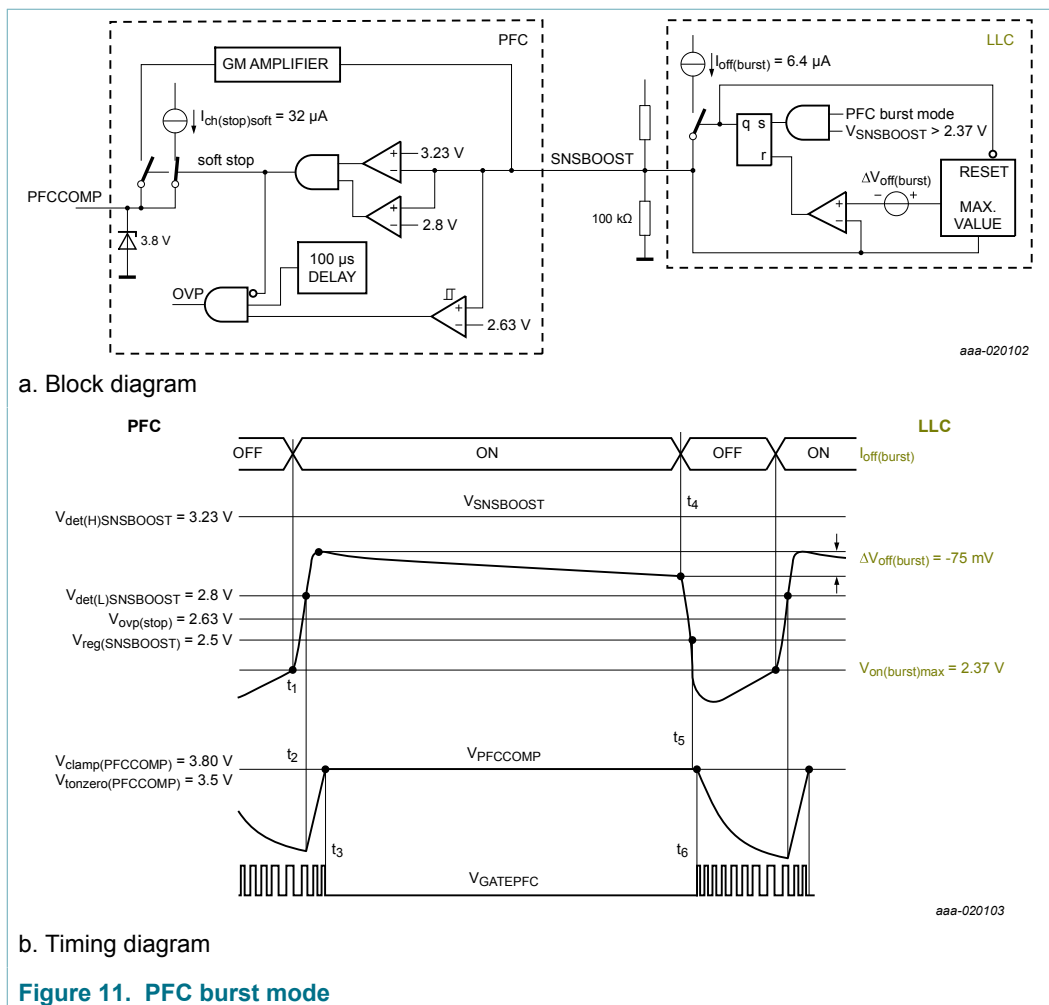


Figure 11. PFC burst mode

At  $t_1$ , the current out of the LLC SNSBOOST pin ( $I_{\text{off(burst)}}$ ) is activated and the voltage on the SNSBOOST pin increases. When a  $100\text{ k}\Omega$  external resistor  $R_{\text{SNSBOOST}}$  between the SNSBOOST pin and GND pin is used (see Figure 11), the SNSBOOST voltage increase is about  $640\text{ mV}$  ( $= I_{\text{off(burst)}} \cdot R_{\text{SNSBOOST}}$ ). As due to this increase the SNSBOOST voltage is between  $V_{\text{det(L)SNSBOOST}}$  and  $V_{\text{det(H)SNSBOOST}}$  levels ( $t_2$ ), the soft stop of the PFC converter is started. In the soft stop state, the current out of the PFCCOMP pin ( $I_{\text{ch(stop)soft}}$ ) is activated. At the end of the soft stop, the PFC enters the energy safe state and stops switching ( $t_3$ ). The voltage at the PFCCOMP pin is clamped at  $V_{\text{tonzero(PFCCOMP)}}$  ( $3.5\text{ V}$ ). It remains at this level during the energy safe state. As the LLC converter operates continuously, even when the PFC is stopped, the PFC output capacitor discharges.

When the PFC boost capacitor is discharged so much that the voltage on the SNSBOOST pin drops by  $75\text{ mV}$  ( $\Delta V_{\text{off(burst)}}$ ;  $t_4$ ), the internal current source in the LLC converter is switched off. Because of the negative voltage drop at the SNSBOOST pin, the SNSBOOST voltage drops below the regulation level ( $V_{\text{reg(SNSBOOST)}}$ ;  $t_5$ ). The PFC starts switching again ( $t_6$ ). When  $V_{\text{SNSBOOST}}$  exceeds the LLC  $V_{\text{on(burst)max}}$  level ( $2.37\text{ V}$ ) again, the internal current is reactivated and the PFC stops switching again.

The TEA19162T current consumption in the burst mode depends on whether the IC is switching or not. During burst mode on-time and burst mode off-time, the current consumption is at operating level and power-saving level, respectively.

### 8.5.3 Soft stop

A soft stop always precedes the PFC burst mode. It reduces audible noise of the converter.

The internal current source activated in the LLC converter (see [Figure 11](#)) pulls up the voltage at the PFC SNSBOOST pin. When the SNSBOOST pin voltage is between  $V_{\text{det(L)SNSBOOST}}$  (2.8 V) and  $V_{\text{det(H)SNSBOOST}}$  (3.23 V), the PFC soft stop begins. Then, a PFC internal current source  $I_{\text{ch(stop)soft}}$  is activated and the transconductance error amplifier in the PFC control loop is switched off (see [Figure 11](#)).

The activated current source provides a current of 32  $\mu\text{A}$  ( $I_{\text{ch(stop)soft}}$ ) out of the PFCCOMP pin. This current slowly increases the voltage of the PFCCOMP pin, gradually reducing the converter switching on-time. When the zero on-time is reached, the soft stop ends. The zero on-time corresponds with the PFCCOMP pin voltage of  $V_{\text{tonzero(PFCCOMP)}}$  (3.5 V).

The detection of the overvoltage on the SNSBOOST pin at the normal OVP level ( $V_{\text{ovp(stop)}}$ ) is delayed for the time  $t_{\text{d(ovp)}}$  (100  $\mu\text{s}$ ). This additional delay is required to verify if the system should stop immediately because of an OVP or via a soft stop when activating the burst mode.

### 8.6 Driver (pin GATEPFC)

The driver circuit to the gate of the power MOSFET has a current sourcing capability of 600 mA and a current sink capability of 1.4 A typical. These capabilities allow a fast turn-on and turn-off of the power MOSFET, ensuring efficient operation.

When the SUPIC voltage is below its start level, the internal keep-off circuitry of the PFC driver pulls down the GATEPFC pin. The pulling down of the GATEPFC pin prevents that an external power MOSFET is activated when the IC power supply is absent or when the  $V_{\text{SUPIC}} < V_{\text{start(SUPIC)}}$ . The keep-off circuitry (see [Figure 12](#)) is supplied via the GATEPFC pin. So, if the actual IC supply is absent or too low ( $V_{\text{SUPIC}} < V_{\text{start(SUPIC)}}$ ), the circuit works correctly.

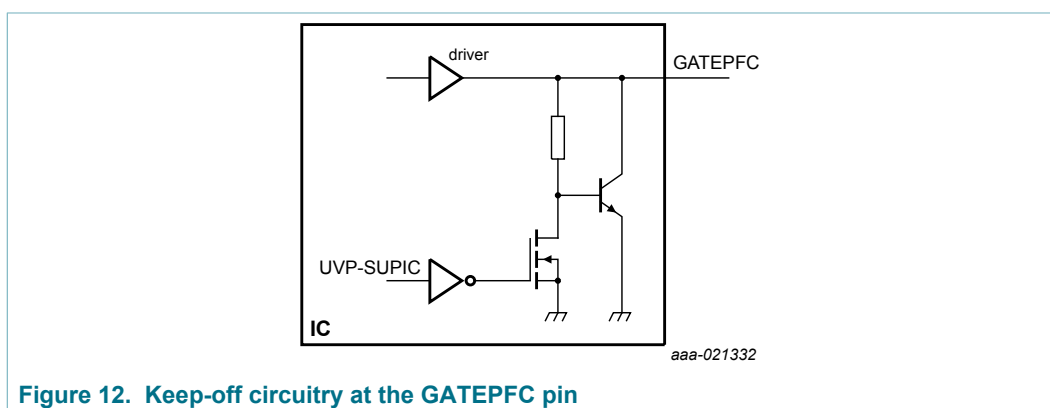


Figure 12. Keep-off circuitry at the GATEPFC pin

## 9 Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol                | Parameter                       | Conditions               |     | Min   | Max   | Unit |
|-----------------------|---------------------------------|--------------------------|-----|-------|-------|------|
| <b>Voltages</b>       |                                 |                          |     |       |       |      |
| V <sub>SUPIC</sub>    | voltage on pin SUPIC            |                          |     | -0.4  | +38   | V    |
| V <sub>SNSMAINS</sub> | voltage on pin SNSMAINS         | current limited          |     | -0.4  | +12   | V    |
| V <sub>PFCCOMP</sub>  | voltage on pin PFCCOMP          | current limited          |     | -0.4  | +12   | V    |
| V <sub>SNSAUX</sub>   | voltage on pin SNSAUX           | current limited          |     | -25   | +25   | V    |
| V <sub>SNSCUR</sub>   | voltage on pin SNSCUR           | current limited          |     | -0.4  | +12   | V    |
| V <sub>SNSBOOST</sub> | voltage on pin SNSBOOST         | current limited          |     | -0.4  | +12   | V    |
| V <sub>GATEPFC</sub>  | voltage on pin GATEPFC          | current limited          |     | -0.4  | +12   | V    |
| <b>General</b>        |                                 |                          |     |       |       |      |
| P <sub>tot</sub>      | total power dissipation         | T <sub>amb</sub> < 75 °C |     | -     | 0.45  | W    |
| T <sub>stg</sub>      | storage temperature             |                          |     | -55   | +150  | °C   |
| T <sub>j</sub>        | junction temperature            |                          |     | -40   | +150  | °C   |
| <b>ESD</b>            |                                 |                          |     |       |       |      |
| V <sub>ESD</sub>      | electrostatic discharge voltage | human body model         | [1] | -2000 | +2000 | V    |
|                       |                                 | charged device model     | [2] | -500  | +500  | V    |

[1] Equivalent to discharging a 100 pF capacitor through a 1.5 kΩ series resistor.

[2] Equivalent to discharging a 200 pF capacitor through a 0.75 μH coil and a 10 Ω resistor.

## 10 Thermal characteristics

**Table 6. Thermal characteristics**

| Symbol               | Parameter                                   | Conditions                    | Typ | Unit |
|----------------------|---------------------------------------------|-------------------------------|-----|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air; JEDEC test board | 150 | K/W  |
| R <sub>th(j-c)</sub> | thermal resistance from junction to case    | in free air; JEDEC test board | 90  |      |

## 11 Characteristics

**Table 7. Characteristics**

$T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $V_{SUPIC} = 20\text{ V}$ ; all voltages are measured with respect to ground (pin 2); currents are positive when flowing into the IC; unless otherwise specified.

| Symbol                                          | Parameter                                    | Conditions                                                                                       | Min   | Typ   | Max   | Unit |
|-------------------------------------------------|----------------------------------------------|--------------------------------------------------------------------------------------------------|-------|-------|-------|------|
| Supply (SUPIC pin)                              |                                              |                                                                                                  |       |       |       |      |
| V <sub>start</sub> (SUPIC)                      | start voltage on pin SUPIC                   |                                                                                                  | 12.35 | 13    | 13.65 | V    |
| V <sub>uvp</sub> (SUPIC)                        | undervoltage protection voltage on pin SUPIC |                                                                                                  | 8.55  | 9     | 9.45  | V    |
| I <sub>CC</sub>                                 | supply current                               | operating mode; f <sub>sw</sub> = 100 kHz; pin GATEPFC = floating; V <sub>SNSBOOST</sub> = 2.2 V | -     | -     | 0.80  | mA   |
|                                                 |                                              | power-save mode; pin PFCCOMP = floating; V <sub>SNSBOOST</sub> = 2.7 V                           | -     | -     | 0.20  | mA   |
| Gate driver output (GATEPFC pin)                |                                              |                                                                                                  |       |       |       |      |
| I <sub>source</sub> (GATEPFC)                   | source current on pin GATEPFC                | V <sub>GATEPFC</sub> = 2 V; V <sub>SUPIC</sub> ≥ 13 V                                            | -     | −0.6  | -     | A    |
| I <sub>sink</sub> (GATEPFC)                     | sink current on pin GATEPFC                  | V <sub>GATEPFC</sub> = 2 V; V <sub>SUPIC</sub> ≥ 13 V                                            | -     | 0.6   | -     | A    |
|                                                 |                                              | V <sub>GATEPFC</sub> = 10 V; V <sub>SUPIC</sub> ≥ 13 V                                           | -     | 1.4   | -     | A    |
| V <sub>o(max)</sub> GATEPFC                     | maximum output voltage on pin GATEPFC        |                                                                                                  | 10.0  | 11.0  | 12.0  | V    |
| Mains voltage sensing (SNSMAINS pin)            |                                              |                                                                                                  |       |       |       |      |
| I <sub>bi</sub>                                 | brownin current                              |                                                                                                  | 5.35  | 5.75  | 6.15  | μA   |
| I <sub>bo</sub>                                 | brownout current                             |                                                                                                  | 4.65  | 5.00  | 5.35  | μA   |
| I <sub>bo(hys)</sub>                            | hysteresis of brownout current               | I <sub>bi</sub> − I <sub>bo</sub>                                                                | 640   | 750   | 820   | nA   |
| t <sub>d(det)bo</sub>                           | brownout detection delay time                |                                                                                                  | 45.2  | 50    | 55.5  | ms   |
| V <sub>regd</sub> (SNSMAINS)                    | regulated voltage on pin SNSMAINS            | mains detection period; no current at SNSMAINS; C <sub>max</sub> (SNSMAINS) = 100 pF             | 230   | 250   | 270   | mV   |
| X-capacitor discharge (SNSCUR and GATEPFC pins) |                                              |                                                                                                  |       |       |       |      |
| t <sub>d(dch)</sub>                             | discharge delay time                         | x-capacitor discharge                                                                            | 109   | 118   | 128   | ms   |
| I <sub>ch</sub> (GATEPFC)                       | charge current on pin GATEPFC                | x-capacitor discharge                                                                            | −29   | −26   | −23   | μA   |
| I <sub>dch</sub> (GATEPFC)                      | discharge current on pin GATEPFC             | x-capacitor discharge                                                                            | 23    | 26    | 29    | μA   |
| V <sub>ch(stop)</sub> SNSCUR                    | stop charge voltage on pin SNSCUR            | x-capacitor discharge; stop of external MOST gate charge; dV/dt = 0                              | 8.00  | 10.50 | 12.50 | mV   |
| V <sub>dch(stop)</sub> GATEPFC                  | stop discharge voltage on pin GATEPFC        | x-capacitor discharge; stop of external MOST gate discharge                                      | 0.3   | 0.7   | 1.1   | V    |
| t <sub>off(dch)</sub>                           | discharge off-time                           | x-capacitor; time between discharge/charge pulses; GATEPFC pin                                   | 1.88  | -     | 6.40  | ms   |

| Symbol                                                                                 | Parameter                                | Conditions                                                                                                            | Min                   | Typ   | Max   | Unit      |
|----------------------------------------------------------------------------------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-----------------------|-------|-------|-----------|
| $T_p$                                                                                  | pulse period                             | x-capacitor discharge;<br>pulse duration < 2 ms (typical);<br>GATEPFC pin                                             | 3.76                  | 4.00  | 4.27  | ms        |
| $V_{dis(dch)GATEPFC}$                                                                  | disable discharge voltage on pin GATEPFC | x-capacitor discharge                                                                                                 | 9.00                  | 9.45  | 9.90  | V         |
| $V_{dis(dch)SNSCUR}$                                                                   | disable discharge voltage on pin SNSCUR  | x-capacitor discharge                                                                                                 | 44                    | 50    | 56    | mV        |
| <b>Output voltage sensing, regulation and compensation (SNSBOOST and PFCCOMP pins)</b> |                                          |                                                                                                                       |                       |       |       |           |
| $V_{reg}(SNSBOOST)$                                                                    | regulation voltage on pin SNSBOOST       | $I_{PFCCOMP} = 0$ A                                                                                                   | 2.475                 | 2.500 | 2.525 | V         |
| $g_m$                                                                                  | transconductance                         | error amplifier;<br>$V_{SNSBOOST}$ to $I_{PFCCOMP}$ ;<br>$ V_{SNSBOOST} - V_{intregd}(SNSBOOST) $<br>< 40 mV          | -90                   | -75   | -60   | $\mu A/V$ |
| $I_{sink}(PFCCOMP)$                                                                    | sink current on pin PFCCOMP              | $V_{SNSBOOST} = 2$ V;<br>$V_{PFCCOMP} = 2.75$ V                                                                       | 30.0                  | 35.5  | 41.0  | $\mu A$   |
| $g_{m(high)}$                                                                          | high transconductance                    | error amplifier;<br>$V_{SNSBOOST}$ to $I_{PFCCOMP}$ ;<br>$V_{start(gm)high} \leq V_{SNSBOOST}$<br>< $V_{stop(ovp)}$   | -                     | -1.26 | -     | $mA/V$    |
| $V_{gm(high)start}$                                                                    | start high transconductance voltage      | pin SNSBOOST                                                                                                          | 2.56                  | 2.60  | 2.63  | V         |
| $I_{clamp(max)}$                                                                       | maximum clamp current                    | pin PFCCOMP; energy save mode; PFC off; $V_{PFCCOMP} = 0$ V                                                           | -260                  | -220  | -190  | $\mu A$   |
| $I_{en}(PFC)$                                                                          | PFC enable current                       | pin PFCCOMP                                                                                                           | -15                   | -11.5 | -8    | $\mu A$   |
| $V_{clamp}(PFCCOMP)$                                                                   | clamp voltage on pin PFCCOMP             | bidirectional clamp; energy save mode; PFC off                                                                        | 3.40                  | 3.50  | 3.60  | V         |
|                                                                                        |                                          | upper clamp voltage; unidirectional clamp; operating mode; PFC on; $I_{PFCCOMP} = 120$ $\mu A$                        | 3.70                  | 3.80  | 3.90  | V         |
|                                                                                        |                                          | lower clamp voltage; unidirectional clamp; operating mode; PFC on; $V_{SNSBOOST} = 2.5$ V; $I_{PFCCOMP} = 30$ $\mu A$ | $V_{tonmax}(PFCCOMP)$ |       |       | V         |

| Symbol                                                  | Parameter                                                  | Conditions                                                                                                                                                         | Min  | Typ  | Max  | Unit             |
|---------------------------------------------------------|------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------------------|
| <b>Mains compensation</b>                               |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $t_{on(PFC)}$                                           | PFC on-time                                                | minimum mains voltage compensation current;<br>$V_{PFCCOMP} = 1.25\text{ V}$ ;<br>$V_{SNSBOOST} = 2.5\text{ V}$ ;<br>$I_{mvc(SNSMAINS)} = 5.25\text{ }\mu\text{A}$ | 30   | 37.5 | 45   | $\mu\text{s}$    |
|                                                         |                                                            | maximum mains voltage compensation current;<br>$V_{PFCCOMP} = 1.25\text{ V}$ ;<br>$V_{SNSBOOST} = 2.5\text{ V}$ ;<br>$I_{mvc(SNSMAINS)} = I_{mvc(max)SNSMAINS}$    | 1.5  | 3    | 4.5  | $\mu\text{s}$    |
| $I_{mvc(max)SNSMAINS}$                                  | maximum mains voltage compensation current on pin SNSMAINS |                                                                                                                                                                    | 18   | 20   | 22   | $\mu\text{A}$    |
| <b>PFC on-timer (PFCCOMP pin)</b>                       |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $V_{tonzero(PFCCOMP)}$                                  | zero on-time voltage on pin PFCCOMP                        |                                                                                                                                                                    | 3.40 | 3.50 | 3.60 | V                |
| $V_{tonmax(PFCCOMP)}$                                   | maximum on-time voltage on pin PFCCOMP                     |                                                                                                                                                                    | 1.18 | 1.23 | 1.28 | V                |
| $f_{sw(PFC)max}$                                        | maximum PFC switching frequency                            |                                                                                                                                                                    | 120  | 134  | 148  | kHz              |
| $t_{off(PFC)min}$                                       | minimum PFC off-time                                       |                                                                                                                                                                    | 1.25 | 1.55 | 1.85 | $\mu\text{s}$    |
| <b>Demagnetization sensing (pin SNSAUX)</b>             |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $V_{det(demag)SNSAUX}$                                  | demagnetization detection voltage on pin SNSAUX            |                                                                                                                                                                    | -125 | -90  | -55  | mV               |
| $t_{to(demag)}$                                         | demagnetization time-out time                              |                                                                                                                                                                    | 37   | 44.5 | 52   | $\mu\text{s}$    |
| $I_{prot(SNSAUX)}$                                      | protection current on pin SNSAUX                           | pin SNSAUX = open;<br>$V_{SNSAUX} = 50\text{ mV}$                                                                                                                  | -    | -40  | -    | nA               |
| <b>Valley sensing (SNSAUX pin)</b>                      |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $(\Delta V/\Delta t)_{vrec(min)}$                       | minimum valley recognition voltage change with time        |                                                                                                                                                                    | -    |      | 1.7  | V/ $\mu\text{s}$ |
| $t_{to(vrec)}$                                          | valley recognition time-out time                           |                                                                                                                                                                    | 3.0  | 3.8  | 4.6  | $\mu\text{s}$    |
| <b>Output current sensing (SNSCUR pin)</b>              |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $V_{reg(oc)}$                                           | overcurrent regulation voltage                             | $dV/dt = 0$                                                                                                                                                        | 0.48 | 0.50 | 0.52 | V                |
| $t_{d(swoff)driver}$                                    | driver switch-off delay time                               | pin GATEPFC                                                                                                                                                        | -    | 80   | -    | ns               |
| $t_{leb}$                                               | leading edge blanking time                                 | $V_{SNSCUR} = 0.75\text{ V}$                                                                                                                                       | 240  | 300  | 360  | ns               |
| $I_{prot(SNSCUR)}$                                      | protection current on pin SNSCUR                           | pin SNSCUR = open                                                                                                                                                  | -    | -50  | -    | nA               |
| <b>Output voltage protection sensing (pin SNSBOOST)</b> |                                                            |                                                                                                                                                                    |      |      |      |                  |
| $I_{pd(SNSBOOST)}$                                      | pull-down current on pin SNSBOOST                          | protection active;<br>$V_{SNSBOOST} = 1.0\text{ V}$ ;                                                                                                              | 85   | 100  | 115  | $\mu\text{A}$    |
| $V_{scp(stop)}$                                         | stop short-circuit protection voltage                      |                                                                                                                                                                    | 0.35 | 0.40 | 0.45 | V                |

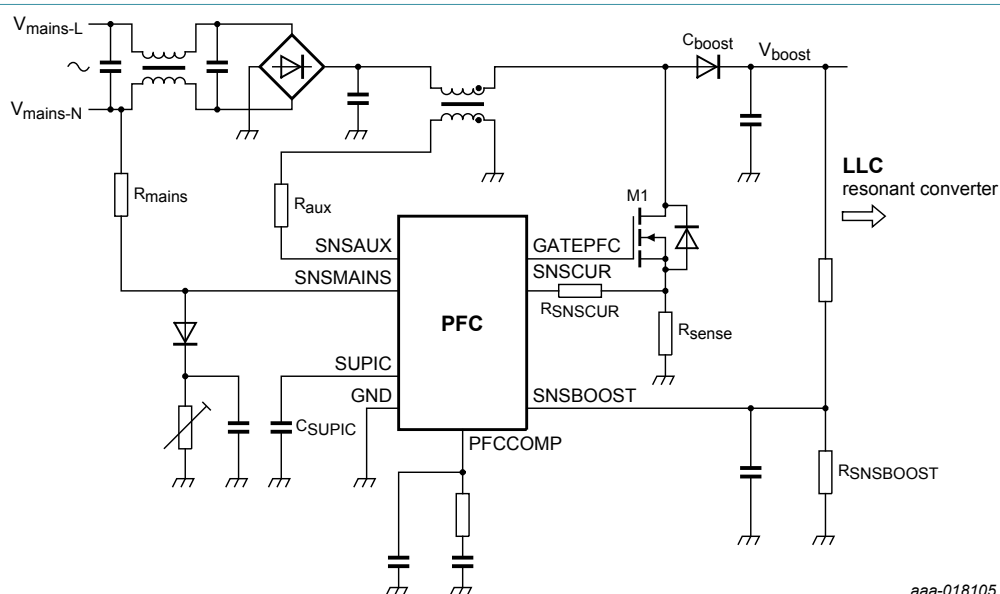
| Symbol                                                   | Parameter                                                 | Conditions                                                             | Min  | Typ  | Max  | Unit               |
|----------------------------------------------------------|-----------------------------------------------------------|------------------------------------------------------------------------|------|------|------|--------------------|
| $V_{scp(start)}$                                         | start short-circuit protection voltage                    |                                                                        | 0.45 | 0.50 | 0.55 | V                  |
| $t_{d(start)}$                                           | start delay time                                          | after short-circuit protection removed                                 | 3.30 | 3.62 | 4.00 | ms                 |
| $I_{pu(rst)SNSBOOST}$                                    | reset pull-up current on pin SNSBOOST                     | fast latch reset;<br>$V_{SNSBOOST} = 1.5\text{ V}$                     | -245 | -210 | -175 | $\mu\text{A}$      |
| $V_{pu(rst)SNSBOOST}$                                    | reset pull-up voltage on pin SNSBOOST                     | fast latch reset                                                       | 1.94 | 2.00 | 2.06 | V                  |
| $I_{prot(SNSBOOST)}$                                     | protection current on open pin SNSBOOST                   | pin SNSBOOST = open                                                    | -    | 35   | -    | nA                 |
| $V_{ovp(stop)}$                                          | stop overvoltage protection voltage                       |                                                                        | 2.59 | 2.63 | 2.67 | V                  |
| $V_{ovp(start)}$                                         | start overvoltage protection voltage                      |                                                                        | 2.47 | 2.53 | 2.59 | V                  |
| $V_{hys(ovp)}$                                           | overvoltage protection hysteresis voltage on pin SNSBOOST | $V_{ovp(stop)} - V_{ovp(start)}$                                       | 0.07 | 0.10 | 0.13 | V                  |
| <b>Soft start (pin SNSCUR)</b>                           |                                                           |                                                                        |      |      |      |                    |
| $t_{start(soft)}$                                        | soft start time                                           |                                                                        | 3.30 | 3.62 | 4.00 | ms                 |
| $V_{start(soft)init}$                                    | initial soft start voltage                                |                                                                        | 100  | 125  | 155  | mV                 |
| <b>Soft stop (pins SNSBOOST and PFCCOMP)</b>             |                                                           |                                                                        |      |      |      |                    |
| $V_{det(L)SNSBOOST}$                                     | LOW-level detection voltage on pin SNSBOOST               | soft stop                                                              | 2.74 | 2.80 | 2.86 | V                  |
| $V_{det(H)SNSBOOST}$                                     | HIGH-level detection voltage on pin SNSBOOST              | soft stop                                                              | 3.17 | 3.23 | 3.29 | V                  |
| $I_{ch(stop)soft}$                                       | soft stop charge current                                  | pin PFCCOMP                                                            | -36  | -32  | -28  | $\mu\text{A}$      |
| $t_{d(ovp)}$                                             | overvoltage protection delay time                         | pin SNSBOOST                                                           | 80   | 100  | 120  | $\mu\text{s}$      |
| <b>External and internal overtemperature measurement</b> |                                                           |                                                                        |      |      |      |                    |
| $I_{en(NTC)}$                                            | NTC enable current                                        | pin SNSMAINS; NTC measurement; mains measurement period; falling slope | 2.0  | 2.5  | 3.0  | $\mu\text{A}$      |
| $I_{o(SNSMAINS)}$                                        | output current on pin SNSMAINS                            |                                                                        | -214 | -200 | -186 | $\mu\text{A}$      |
| $t_{det(NTC)max}$                                        | maximum NTC detection time                                |                                                                        | 0.92 | 1.00 | 1.08 | ms                 |
| $V_{det(SNSMAINS)}$                                      | detection voltage on pin SNSMAINS                         | NTC measurement;<br>$I_{SNSMAINS} = -200\text{ A}$                     | 1.95 | 2.00 | 2.05 | V                  |
| $T_{pl(IC)}$                                             | IC protection level temperature                           |                                                                        | 130  | 150  | 160  | $^{\circ}\text{C}$ |

## 12 Application information

Capacitor C<sub>SUPIC</sub> filters the IC supply voltage, which must be supplied externally. Sense resistor R<sub>sense</sub> converts the current through the MOSFET M1 to a voltage on the SNSCUR pin. The R<sub>sense</sub> value determines the maximum primary peak current in MOSFET M1.

To limit the current into the SNSCUR pin due to negative voltage spikes across the sense resistor, resistor  $R_{SNSCUR}$  is added.

To protect the IC from damage during lightning events, resistor  $R_{aux}$  is added.

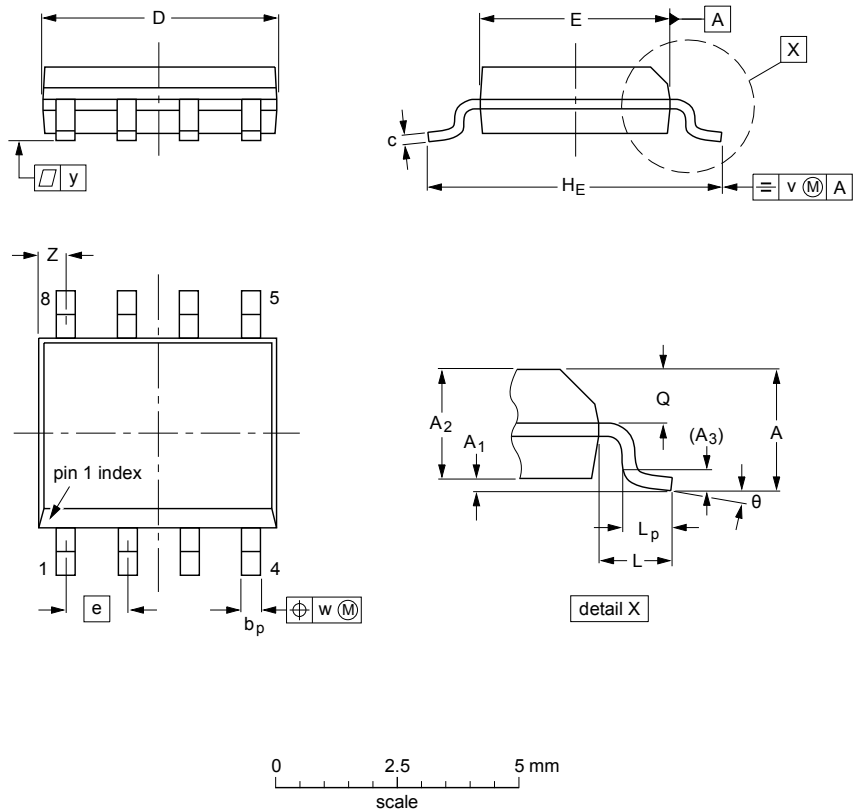


### Figure 13. Application diagram

13 Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A <sub>max.</sub> | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c                | D <sup>(1)</sup> | E <sup>(2)</sup> | e    | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | θ        |
|--------|-------------------|----------------|----------------|----------------|----------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 1.75              | 0.25<br>0.10   | 1.45<br>1.25   | 0.25           | 0.49<br>0.36   | 0.25<br>0.19     | 5.0<br>4.8       | 4.0<br>3.8       | 1.27 | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8°<br>0° |
| inches | 0.069             | 0.010<br>0.004 | 0.057<br>0.049 | 0.01           | 0.019<br>0.014 | 0.0100<br>0.0075 | 0.20<br>0.19     | 0.16<br>0.15     | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.024 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   |          |

- Notes
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.
  2. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT96-1            | 076E03     | MS-012 |       |  |                        | 99-12-27<br>03-02-18 |

Figure 14. Package outline SOT96-1 (SO8)

## 14 Revision history

Table 8. Revision history

| Document ID    | Release date                                                                                                                                                                                                                                                                                                                                                       | Data sheet status  | Change notice | Supersedes      |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|---------------|-----------------|
| TEA19162T v.3  | 20180507                                                                                                                                                                                                                                                                                                                                                           | Product data sheet | -             | TEA19162T v.2.0 |
| Modifications: | <ul style="list-style-type: none"><li>• <a href="#">Section 5</a>, Marking, has been added to the data sheet.</li><li>• <a href="#">Figure 4</a>, Start-up of the PFC and LLC, has been updated.</li><li>• <a href="#">Figure 11</a>, PFC burst mode, has been updated.</li><li>• <a href="#">Section 10</a>, Thermal characteristics, has been updated.</li></ul> |                    |               |                 |
| TEA19162T v.2  | 20160413                                                                                                                                                                                                                                                                                                                                                           | Product data sheet | -             | TEA19162T v.1.0 |
| Modifications: | <ul style="list-style-type: none"><li>• Text and graphics have been updated throughout the data sheet.</li></ul>                                                                                                                                                                                                                                                   |                    |               |                 |
| TEA19162T v.1  | 20160310                                                                                                                                                                                                                                                                                                                                                           | Product data sheet | -             | -               |

## 15 Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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